Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	- 50				
R _{DS(on)} (Ω)	$V_{GS} = -10 V$	0.50			
Q _g (Max.) (nC)	11				
Q _{gs} (nC)	3.8				
Q _{gd} (nC)	4.1				
Configuration	Single				

HVMDIP

P-Channel MOSFET

FEATURES

- For Automatic Insertion
- · Compact, End Stackable
- · Fast Switching
- Low Drive Current
- Easy Paralleled
- Excellent Temperature Stability
- P-Channel Versatility
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

The HVMDIP technology is the key to Vishay's advanced line of power MOSFET transistors. The efficient geometry and unique processing of the HVMDIP design achieves very low on-state resistance combined with high transconductance and extreme device ruggedness.

The p-channel HVMDIPs are designed for application which require the convenience of reverse polarity operation. They retain all of the features of the more common n-channel HVMDIPs such as voltage control, very fast switching, ease of paralleling, and excellent temperature stability.

P-channels HVMDIPs are intended for use in power stages where complementary symmetry with n-channel devices offers circuit simplification. They are also very useful in drive stages because of the circuit versatility offered by the reverse polarity connection. Applications include motor control, audio amplifiers, switched mode converters, control circuits and pulse amplifiers.

ORDERING INFORMATION	
Package	HVMDIP
Lead (Pb)-free	IRFD9010PbF
	SiHFD9010-E3
SnPb	IRFD9010
	SiHFD9010

ABSOLUTE MAXIMUM RATINGS ($T_C = 25$ °C, unless otherwise noted)							
PARAMETER			SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	- 50	V		
Gate-Source Voltage			V _{GS}	± 20	v		
Continuous Drain Current	V _{GS} at - 10 V	T _C = 25 °C	- I _D	- 1.1			
		T _C = 100 °C		- 0.68	А		
Pulsed Drain Current ^a			I _{DM}	- 8.8			
Linear Derating Factor				0.01	W/°C		
Inductive Current, Clamped	L = 100 µH see fig. 14		I _{LM}	- 8.8	A		
Inductive Current, Unclamped (Avalanche Current)	see fig. 15		١L	- 1.5			
Maximum Power Dissipation	T _C = 25 °C		PD	1	W		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to + 150	°C			
Soldering Recommendations (Peak Temperature)	for 10 s			300 ^d	U		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = -25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 52 mH, $R_a = 25 \Omega$, $I_{AS} = -2.0 \text{ A}$ (see fig. 12).

c. $I_{SD} \leq$ - 4.0 A, dI/dt \leq 75 A/µs, $V_{DD} \leq V_{DS}$, $T_J \leq$ 175 °C.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply





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PARAMETER	SYMBOL	TYP. MAX. - 120			UNIT			
Maximum Junction-to-Ambient	R _{thJA}				°C/W			
SPECIFICATIONS ($T_J = 25 \text{ °C}$, u	nless otherw	vise noted)						
PARAMETER	SYMBOL	TES	T CONDITIONS		MIN.	TYP.	MAX.	UNI
Static		•						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, I _D = - 250 μ/	4	- 50	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = - ⁻	1 mA	-	- 0.091	-	V/°0
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	V _{GS} , I _D = - 250 μ	Ą	- 2.0	-	- 4.0	V
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 20 V$		-	-	± 500	nA
		V _{DS} =	- 50 V, V _{GS} = 0 \	/	-	-	- 250	
Zero Gate Voltage Drain Current	IDSS	V _{DS} = - 40 V	$V_{\rm H},V_{\rm GS}=0V,T_{\rm J}=0$	125 °C	-	-	- 1000	μA
On-State Drain Current	I _{D(on)}	$V_{GS} = 10 \text{ V}$	$V_{DS} > I_{D(on)} \times R_{D}$	_{S(on)} max.	- 1.1	-	-	A
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = - 10 V	I _D = - 0.58	3 A ^b	-	0.35	0.50	Ω
Forward Transconductance	g fs	V _{DS} =	= - 20 V, I _D = - 2.4 A		1.7	2.5	-	S
Dynamic								
Input Capacitance	C _{iss}	V _{GS} = 0 V,			-	240	-	pF
Output Capacitance	Coss	$V_{DS} = -25 V,$ f = 1.0 MHz, see fig. 5		-	160	-		
Reverse Transfer Capacitance	C _{rss}			-	30	-		
Total Gate Charge	Qg			= - 4.7 A, V_{DS} = 0.8 V see fig. 6 and 13 ^b	-	7.2	11	nC
Gate-Source Charge	Q _{gs}	V _{GS} = - 10 V			-	2.5	3.8	
Gate-Drain Charge	Q _{gd}	1	see ng. e u		-	2.7	4.1	
Turn-On Delay Time	t _{d(on)}	$V_{DD} = -25 \text{ V}, \text{ I}_{D} = -4.7 \text{ A}$ R _g = 24 Ω, R _D = 5.6 Ω, see fig. 10 ^b		-	6.1	9.2	- ns	
Rise Time	tr			-	47	71		
Turn-Off Delay Time	t _{d(off)}			-	13	20		
Fall Time	t _f	1			-	39	59	1
Internal Drain Inductance	L _D	Between lead, 6 mm (0.25") from		-	4.0	-	nL	
Internal Source Inductance	L _S	package and center of die contact			-	6.0	-	nH
Drain-Source Body Diode Characteristic	s	-						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	- 1.1	A	
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode			-	-	- 8.8	
Body Diode Voltage	V_{SD}	$T_J = 25 \ ^\circ C, \ I_S = - \ 0.7 \ A, \ V_{GS} = 0 \ V^b$		-	_	- 5.5	V	
Body Diode Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = -4.7 \text{ A}, dI/dt = 100 \text{ A}/\mu\text{s}^b$		33	75	160	ns	
Body Diode Reverse Recovery Charge	Q _{rr}			0.090	0.22	0.52	μ	
Forward Turn-On Time	t _{on}	Intrinsic to	urn-on time is neg	gligible (turr	n-on is do	minated b	y L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

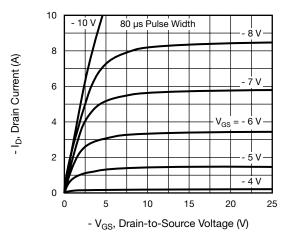


Fig. 1 - Typical Output Characteristics

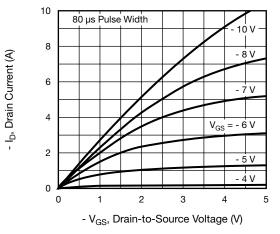


Fig. 2 - Typical Output Characteristics

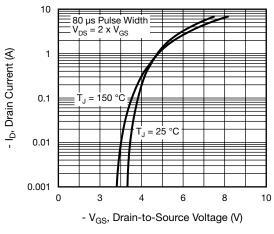


Fig. 3 - Typical Transfer Characteristics

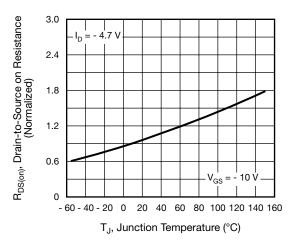


Fig. 4 - Normalized On-Resistance vs. Temperature

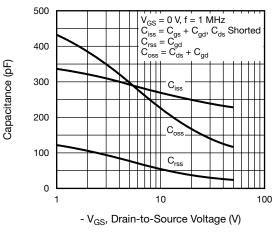


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

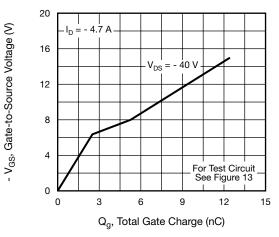


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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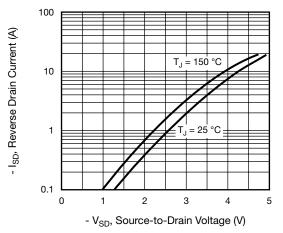


Fig. 7 - Typical Source-Drain Diode Forward Voltage

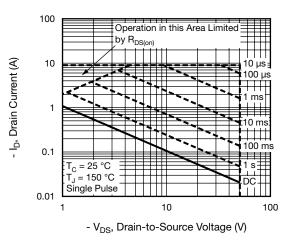


Fig. 8 - Maximum Safe Operating Area

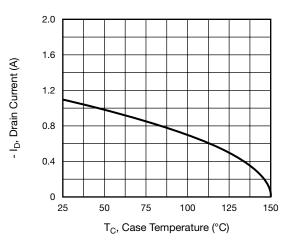


Fig. 9 - Maximum Drain Current vs. Case Temperature

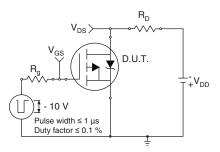


Fig. 10a - Switching Time Test Circuit

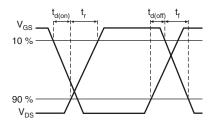


Fig. 10b - Switching Time Waveforms

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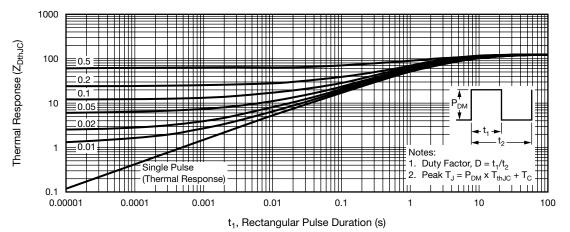


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

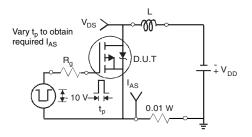


Fig. 12a - Unclamped Inductive Test Circuit

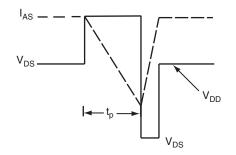


Fig. 12b - Unclamped Inductive Waveforms

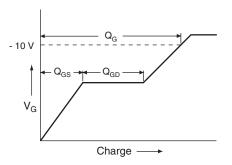


Fig. 13a - Basic Gate Charge Waveform

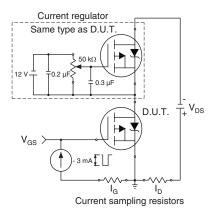
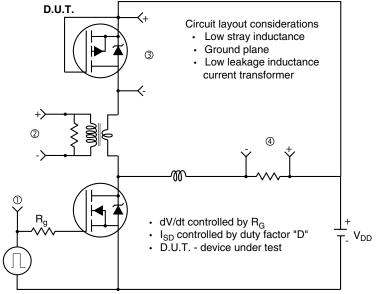


Fig. 13b - Gate Charge Test Circuit

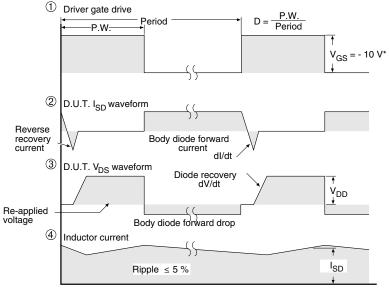
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Peak Diode Recovery dV/dt Test Circuit



• Compliment N-Channel of D.U.T. for driver



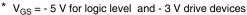


Fig. 14 - For P-Channel

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